



USPAS - Fundamentals of Ion Sources 7. Multicusp Ion Sources II

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Outline

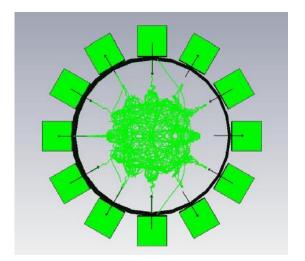
- Introduction basic principles of multicusp ion sources
- Different heating methods (filament, RF antenna, ECR?)
- Usages: H+, H-, He+, H2+, ...
- Positive (H+, H2+, He+, ...) multicusp ion sources
 - Optimization
- Negative (H-, ...) multicusp ion sources
 - Volume production
 - Surface-enhanced volume production (Cs)
 - Extraction of negative ions
 - Optimization
- Other types of negative ion sources

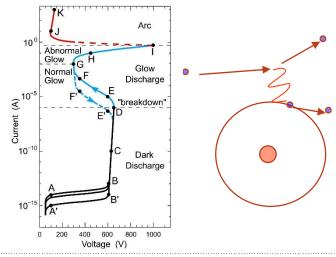




Quick Recap of Multicusp so far

- Ions and Electrons are confined in a multicusp magnetic field
- Electrons are given energy through an electric field (either by DC voltage or RF)
- Ionization through electron impact
- Many parameters that depend on the application







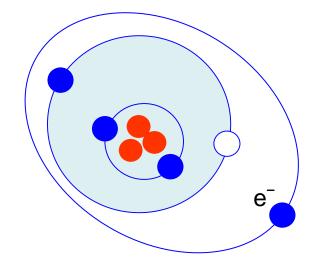
Parameter	Typical Values	Comment		
Permanent Magnet Multicusp Magnetic Field	0.8 – 1.4 T 8 – 16-Pole Front/Sides/ Back	No	Most likely need cooling. NdFe has higher field SmCo better Tc	
Filament Heating			Many Parameters	
Heating Current	O(10A)	Yes		
Discharge Current	O(1A)	Yes		
Discharge Voltage	O(100V)	Yes		
Filament Position	O(10cm)	Somewhat	Depends on Ion	
Filament Material	W, Ta, LaB ₆	Somewhat	Filament Shape? Lifetime	
RF Heating				
Frequency	5~13 MHz	Somewhat		
Power	few – 100 kW	Yes		
Material/Gas	1e-5 to 1e-3 Torr	Yes		
Extraction	Up to 100 kV	Somewhat	Depends strongly on application!	





Negative lons

 Especially atoms with an open shell attract an extra electron and can form a stable ion with a net charge of –e.



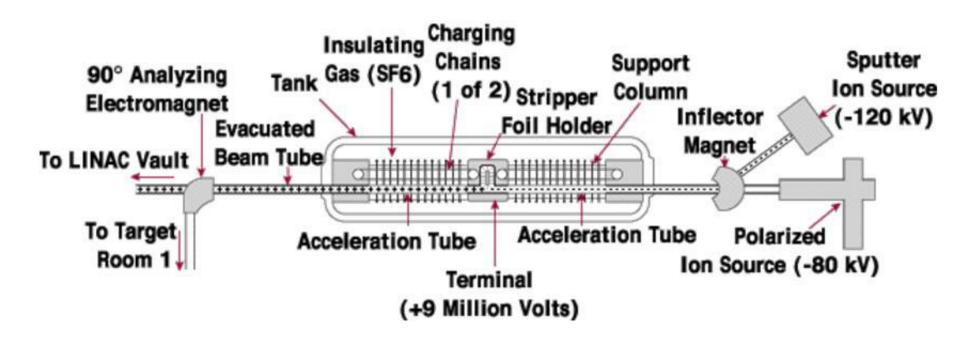
- The stability is quantified by the electron affinity, the minimum energy required to remove the extra electron.
- The electron affinities are substantially smaller than the ionization energies, covering the range between 0.08 eV for Ti⁻ and 3.6 eV for Cl⁻, e.g. 0.75 eV for H⁻.
- For electron energies above 10 eV, the H⁻ ionization cross section is ~30.10⁻¹⁶ cm², ~30 times larger than for a typical neutral atom!!
- For H⁺ energies below 1 keV, the recombination cross section is larger than 100.10⁻¹⁶ cm².
- Charged particle collisions destroy negative ions easily!!





Why Negative Ions?

Historically: Tandem Accelerators



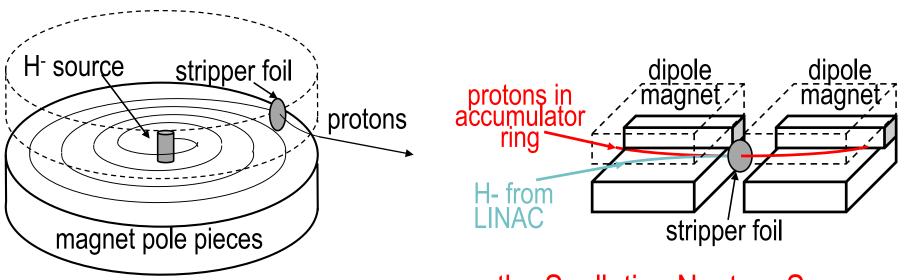


(Adapted from M. Stöckli, ORNL)



Why Negative lons?

 Stripping Extraction from Cyclotrons Accumulating lons in a limited Phase Space:



e.g. the Spallation Neutron Source

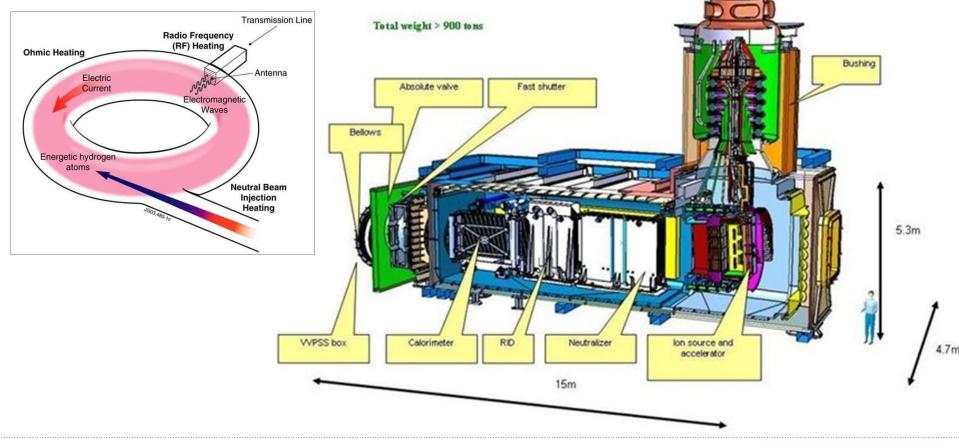


(Adapted from M. Stöckli, ORNL)



Why Negative Ions?

Neutral Beam Injection





From: http://www.iter.org/mach/heating



Brief History of H⁻ sources

- 1977: M. Bacal finds large negative ion fraction in hydrogen plasma
- 1982: Ehlers, Leung & Bacal invent the "tandem source" at LBNL
- Several volume H⁻ sources were developed, including the DESY RF source with an external antenna. It produced 0.1 ms long, 40 mA H⁻ pulses at 5 Hz with a lifetime exceeding 1 year.
- Parallel, since 1960 the use of Cs in ion sources to increase negative ion currents is studied.













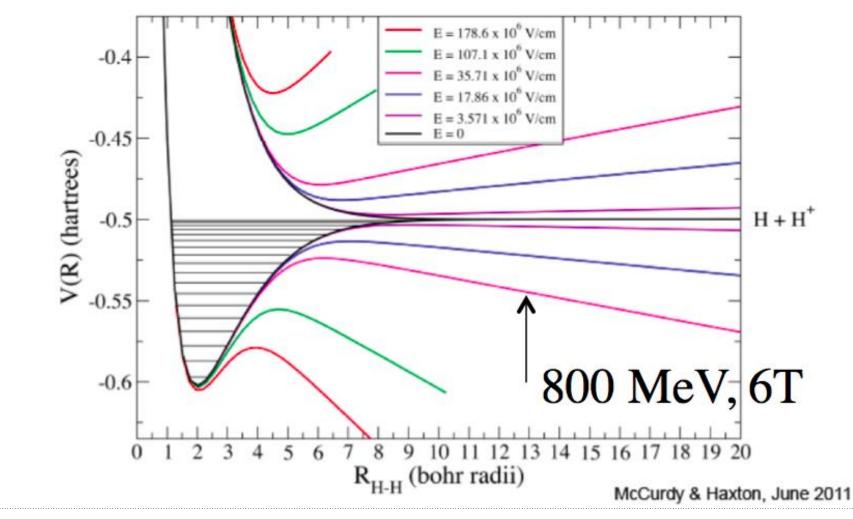
Volume Production of H⁻

- Conserving energy & momentum when forming a negative ion through direct electron attachment, the excess energy has to be dissipated through a photon: H + e = H⁻ + γ
- But few H⁰ allow for Radiative Capture (10⁻¹⁸ cm² for E_e~1eV)
- More likely are processes where excess energy can be transferred to a third particle, H₂ + e = H + H + e and sometimes = H + H⁻
 (~10⁻²⁰ cm² for H₂ and E_e >7 eV)
- Most likely is the excitation of a molecule to the edge of breakup: $H_2 + e(fast) = H_2^{\nu} + e$ (~5.10⁻¹⁸cm² for $4 \le \nu \le 9$ & $E_e > 20 eV$) and then dissociated by a slow electron: $H_2^{\nu} + e(slow) = H + H^- (<10^{-15} cm^2 for <math>4 \le \nu \le 9$ & $E_e \sim 1eV$)





Vibrational States (+Lorentz Stripping)

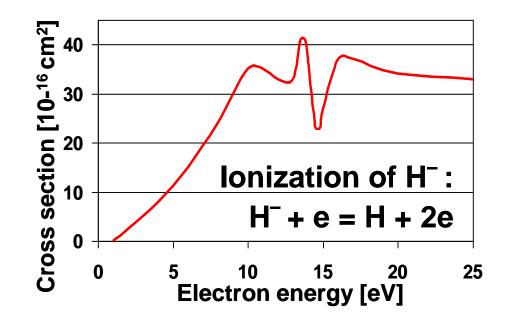






Problem is...

 Fast electrons needed to excite the molecules destroy (~3.10⁻¹⁵cm²) the H⁻!





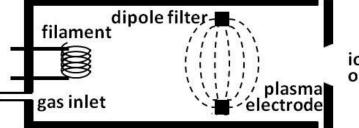


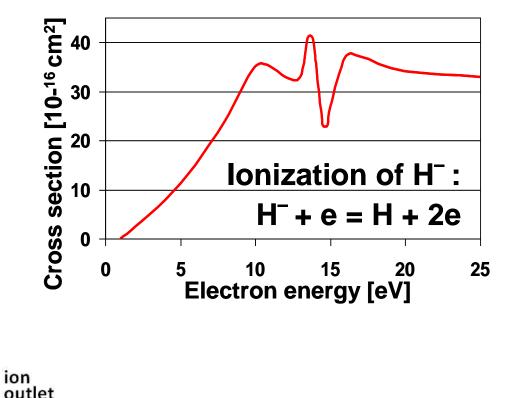


Problem is...

- Fast electrons needed to excite the molecules destroy (~3.10⁻¹⁵cm²) the H⁻!
- Solution: "Tandem Source"









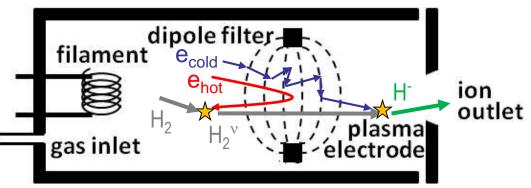




Magnetic Filter

- The magnetic filter reflects energetic electrons, e.g. 200 Gauss turn around 35-eV electrons on a 1 mm radius.
- Cold electrons and ions undergo many collisions with other particles, resulting in a diffusion process that favors cold charged particles ($v_{diff} \sim T^{-\frac{1}{2}}$).
- Excited neutral molecules migrate freely through the filter field & can break up near the outlet.

Tandem Source

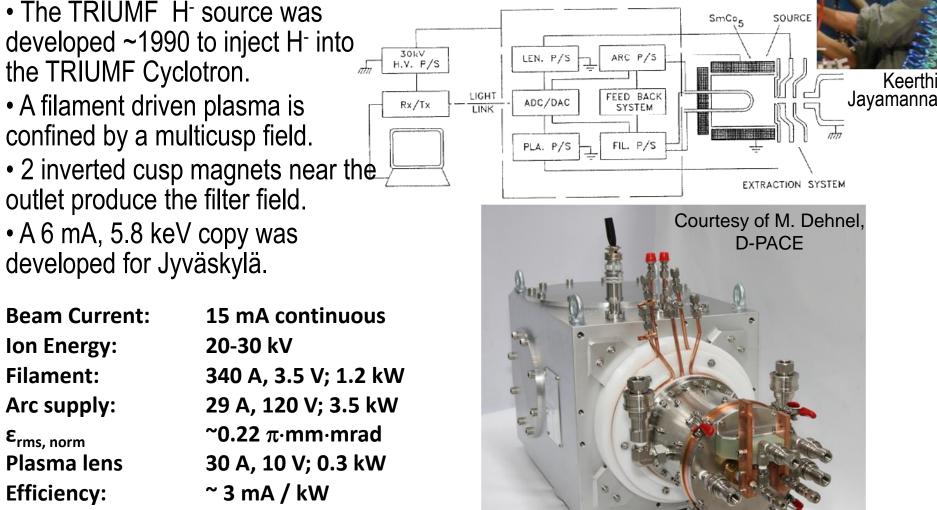






The TRIUMF H⁻ Source

K. Jayamanna, M. McDonald, D.H. Yuan, P.W. Schmor, EPAC (1990) 647



Filament lifetime:

≥14 days at peak current

RERKELE

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Keerthi

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RF Heating	Many Parameters		
Filter Field	O(100 Gauss)	Somewhat	
Material/Gas	1e-5 to 1e-3 Torr	Yes	
Extraction	Up to 100 kV	Somewhat	Depends strongly on application!

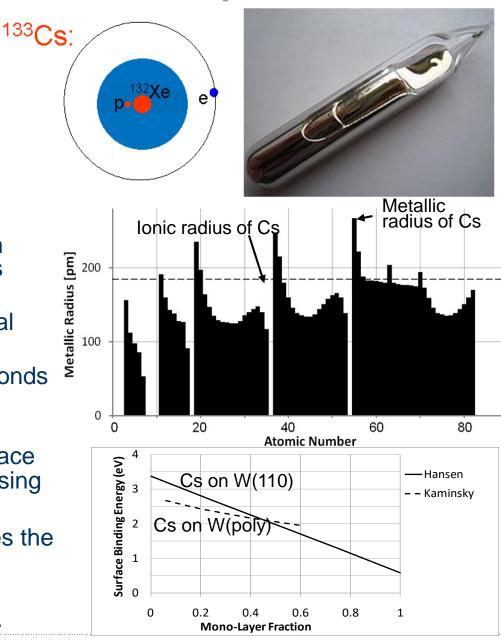
Sources can deliver ~15 mA DC, up to 50 mA pulsed. Now improve extracted current with Cs...





Cesium on Metal Surfaces

- Cs is ¹³²Xe +1 proton +1 electron.
- The largest atom (2.65 A radius).
- The smallest ionization energy 3.9eV
- Small density: 1.9 g/cm³
- Low melting point: 28.4°C.
- Cs atoms on clean metal surfaces form ionic-like bonds as their outer electrons mix with the conduction electrons.
- Ionic bonds are strong, resisting thermal emission as well as sputtering.
- Additional layers of Cs form covalent bonds with ~0.5 eV, which easily break.
- The Cs diameter being larger than the substrate matrix lattice causes the surface binding energy to decrease with increasing surface coverage.
- The increasing binding energy stabilizes the thermal emission.
- This allows for controlling the surface coverage with the surface temperature.



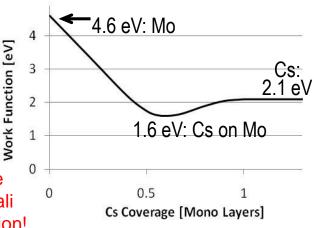


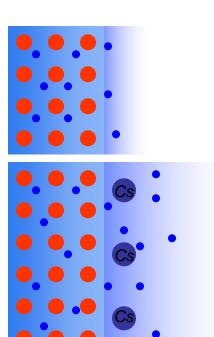


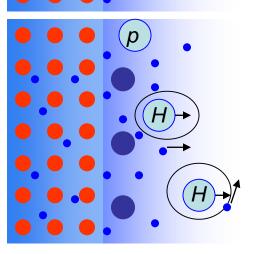
Surface Production of H⁻ Ions

- Metals host an abundance of loosely-bound conduction electrons, but it takes about 4.5 to 6 eV to remove an electron from the surface.
- Alkali metals have lower work functions (2-3 eV). When adsorbed on a metal surface as a partial monolayer, alkali atoms can lower the surface work function below their bulk work function.
- Lowering the work function increases the probability that fast hydrogen atoms leaving the surface capture a second electron.
- Protons capturing an electron when hitting the surface and hyper-thermal atoms can capture a 2nd electron when bouncing back into the plasma.

In the absence of Cs, residues on the surface (H_2O) and/or sputtered atoms (especially alkali from ceramics) can also lower the work function!







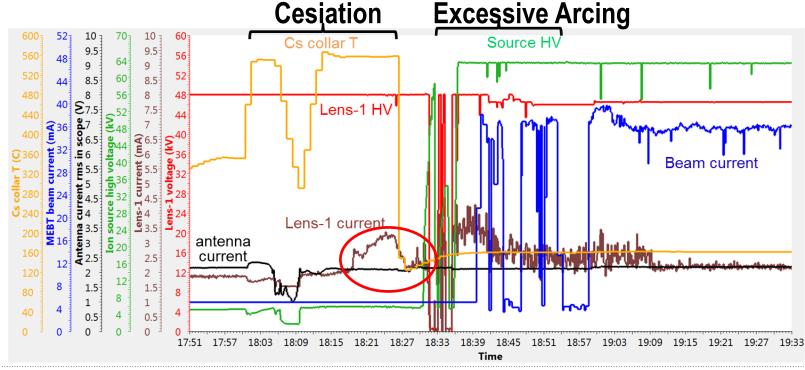


(Adapted from M. Stöckli, ORNL)



Problems with Cs (SNS Example)

- Cs lowers the work function, which increases the production of negative ions AND the emission of electrons from negatively charged ion source and associated electrodes (Lens-1).
- Uncontrolled discharges can damage or disable systems and cause extended down time.
- Cs needs to be minimized near HVs!







The SNS Cs₂CrO₄ System:

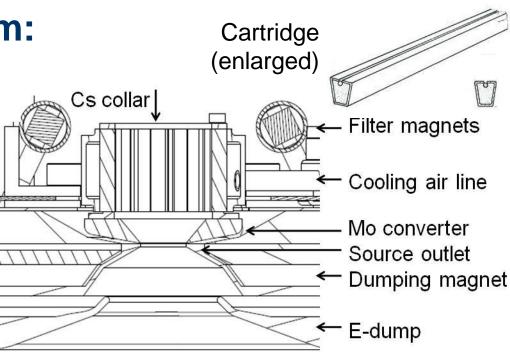
• To minimize Cs-induced arcing in the compact SNS LEBT, LBNL introduced 8 Cs_2CrO_4 cartridges (SAES Getters), which together contain <30 mg Cs. Integrated into $\frac{1}{22}$ the Cs collar, the compact system allows for rapid startups!

•The Mo ion converter is electrically and thermally attached

the Cs collar. The temperature of the system is controlled with heated air.

- •Right after being evacuated, the system is outgassed at 250°C and the Mo converter is sputter-cleaned for ~3 hours. Then the collar is heated for 12 minutes to 550°C to release ~4 mg of Cs. Then the temperature is lowered to ~170°C. This appears to produce a nearly optimal monolayer of Cs, which becomes persistent.
- •Some times a few mA are lost in the 1st few hours.
- •Often the H⁻ beam grows a few mA for a few days.
- •Then the beam becomes persistent, practically free of decay!

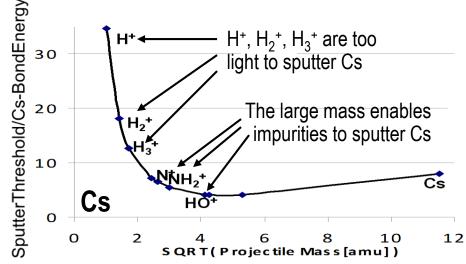
SNS produces >9 kC or >2.5 A h of H ions without any maintenance!





Requirements for Persistent H⁻ Beams

- To obtain persistent beams with Cs-enhanced H⁻ sources, a stable fractional mono layer of Cs needs to be maintained.
- Cs can be lost through thermal emission and through sputtering.
- In Cs-enhanced H⁻ sources some Cs is lost and replaced through a small flux of Cs, which requires experience; e.g.; the Hera magnetron started with 6 mg/day in 1993 and ended with 0.7 mg/day in 2008.
- The LANCE source requires ~1 g/day, ~10³ times more.
- However, when scaled with the plasma duty factor, LANCE requires ~8 g/plasma-day, whereas DESY required 37g/plasma-day in 2008.
- At such rates the SNS source would run out of Cs in ~1 hour!
- The ~4 mg Cs in the SNS H⁻ source yield ~50 mA H⁻ beam for up to 6 weeks.
- This corresponds to ~0.12 mg/day or ~2 mg/plasma-day, >4000 times less than other H⁻ sources.
- Apparently, the SNS H⁻ source is sputter-free due to its low plasma potential and its high purity of the hydrogen plasma!



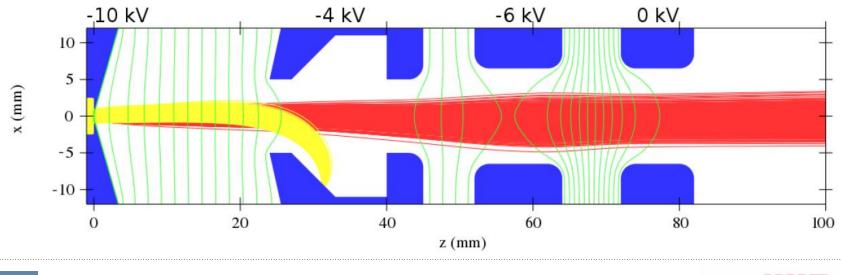
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Filament Heating	Many Parameters			
RF Heating	Many Parameters			
Filter Field	O(100 Gauss)	Somewhat		
Cesium	> .12 mg/plasma-day	Somewhat	Can lead to sparking	
Material/Gas	1e-5 to 1e-3 Torr	Yes		
Extraction	Up to 100 kV	Somewhat	Depends strongly on application!	





Co-extracted Electrons

- Electron Current can be much higher than ion current.
- Poses a real problem for damaging parts of the beam line if not disposed of in a controlled fashion.
- Extraction system needs to include electron dump.
- Electrons can be diverted electrostatically or magnetically (typical).



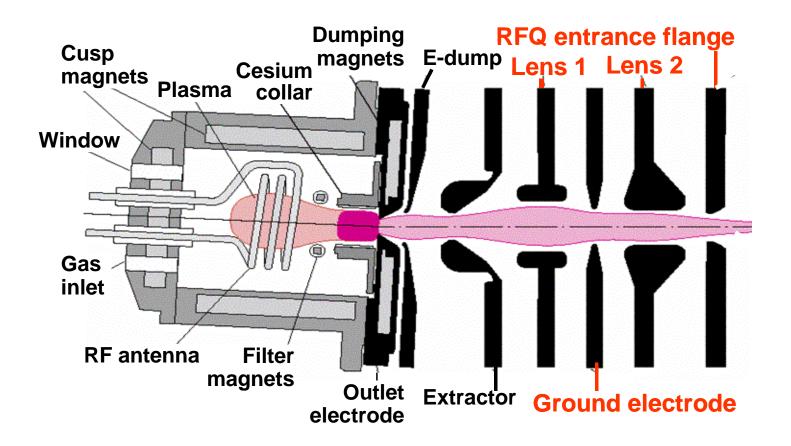


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Cesium	> .12 mg/plasma-day	Somewhat	Can lead to sparking		
Material/Gas	1e-5 to 1e-3 Torr	Yes			
Extraction	Depends strongly on application: Up to 100 kV for positive ions -10's of kV for negative ions	Somewhat	Depends strongly on application: Negative: Electron Dump!		



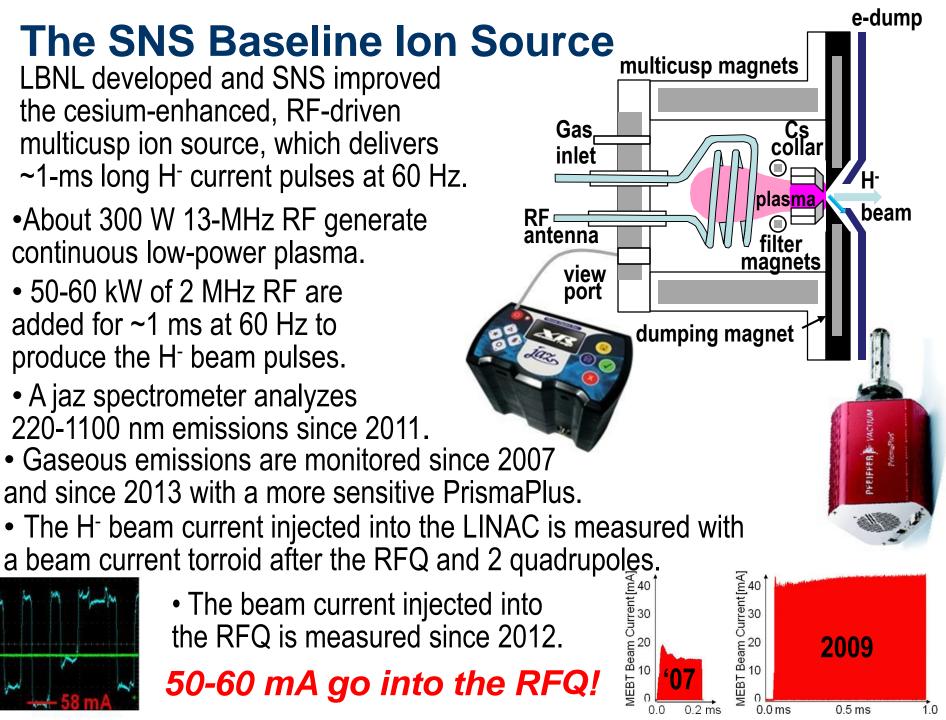


Examples: SNS Ion Source









MW Waveguide Coupled Heating

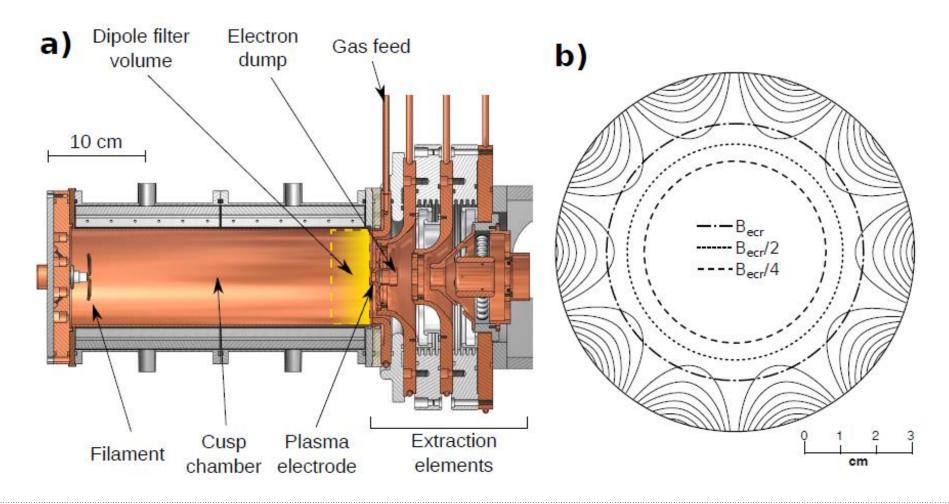
- Microwave system from 2.45 GHz off-resonance ECR
- Ridged waveguide
- Quartz window Solenoid Magnetron Ridged Plasma chamber waveguide Diagnostic Circulator port Faraday cup Stub tuners Extraction system 10 cm Quartz window HV insulator and BN disc







LIISA Source



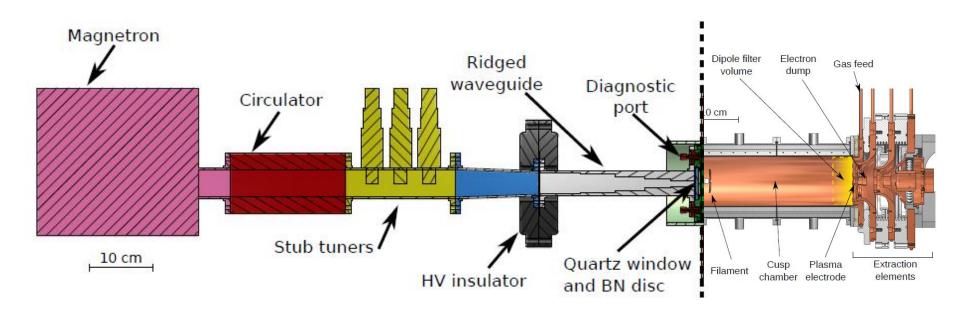


J. Komppula, NIBS 2014



LIISA Source

- Originally: Filament driven discharge H- source
- Now coupled with Magnetron for ECR heating

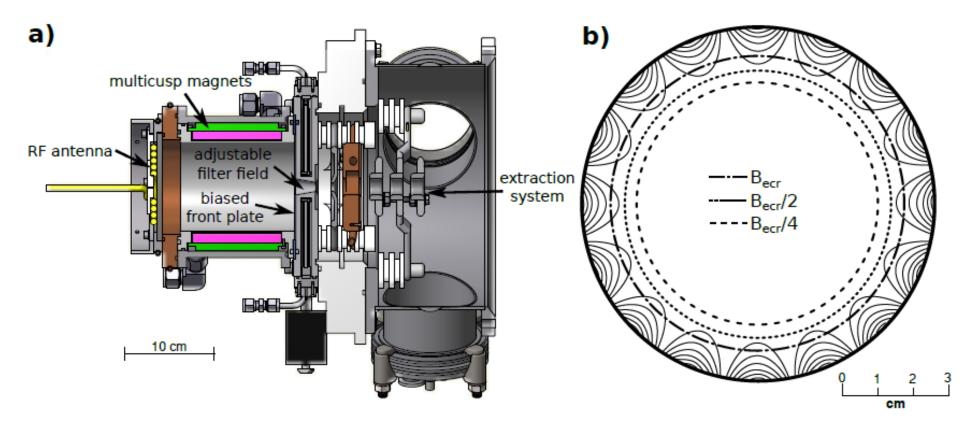






RADIS Source

RF-driven discharge RADIS



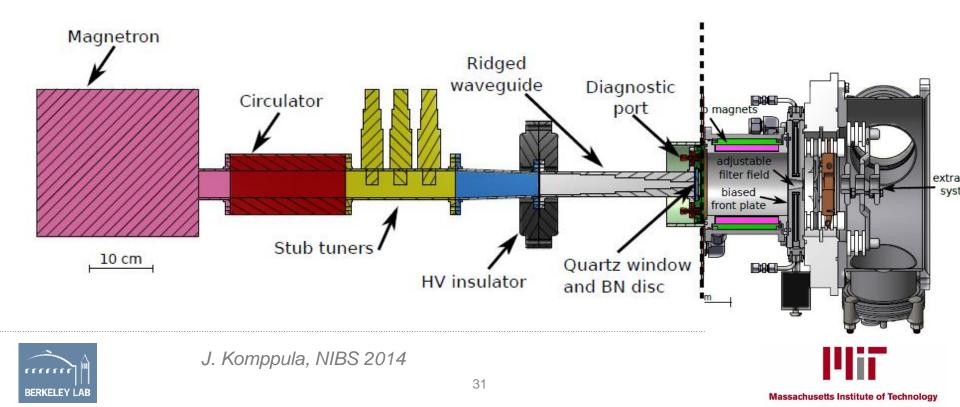


J. Komppula, NIBS 2014



RADIS Source

- Originally: RF driven H- source
- Now coupled with Magnetron for ECR heating



ECR Heating Results

TABLE 1. Measured H^- beam currents and tuning parameters for different ion sources and heating methods. A heating power of 1 kW has been used in each case. The reported beam currents are achieved with pure hydrogen. The boron nitride disc was used in front of the quartz microwave window in the case of RADIS, but not in the case of LIISA.

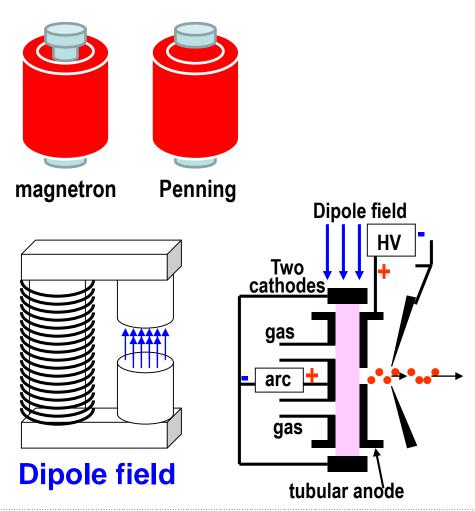
	RADIS RF	RADIS 2.45 GHz	LIISA filament	LIISA 2.45 GHz	
H ⁻ beam current	300	170	1500	500	μA
H ⁻ current density	0.78	0.44	1.6	0.53	mA/cm ²
e/H ⁻	10-30	25-35	2-4	5-15	
Pressure	0.5 - 1	1	0.45	0.65	Pa
Plasma electrode	7-12	0	1–4	2-15	V
Ignition thresholds					
Pressure	≈ 4.5	≈4.5	-	0.75	Pa
Power	≈ 1.0	≈ 1.5	-	≈1.5	kW





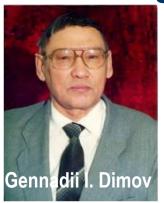
Other Types of Negative Ion Sources

- Magnetron
- Penning
- Compact Surface Plasma Sources (CSPS)
- Penning ion beams tend to be noisy and drift during operation.
- The ion induced sputtering of the cathode enables metal beams, but also limits the ion source lifetime!





Cs in Negative Ion Sources







In the early 1970s, before the Cs physics was understood, G. Dimov, Y. Belchenko, and V. Dudnikov added Cs to their magnetron source increasing the H⁻ current to 150 mA



for up to 0.5% duty factors. Y. Belchenko, G. Dimov, V. Dudnikov, *Nucl. Fusion, 14, 113 (1974)*

magnetron

Compact Surface

Plasma Sources

(CSPS)

Penning

Then Vadim Dudnikov developed a Penning H⁻ source that delivers 150 mA with a 1% duty factor.

With the Siberian "Know How",

- BNL Krsto Prelec et al. developed magnetrons for NBI.
- LANL Paul Allison et al. developed Penning H⁻ sources.
- LBNL Ehlers and Leung developed Surface Converter H⁻ sources for LANL.
- FNAL Chuck Schmidt et al. developed the BNL magnetron for accelerators.

Recently, Yuri Belchenko developed a hollow cathode Penning source delivering 25 mA H- DC!

The RAL ISIS Penning H- Source

- In the early 1980s RAL develops the ISIS Penning H⁻ source by combining a LANL Penning design with some features from the FNAL magnetron.
- The design evolved over the years.
- Since 2002 Dan Faircloth leads the effort.
- It currently produces 35 mA H⁻ 0.25 ms pulses at 50 Hz for the 160 kW ISIS neutron source.
- It consumes 3 mg Cs per hour or ~2 g in its ~25 days lifetime. The Cs is trapped by the 90° dipole magnet inside a cold box.
- Using 0.8 ms plasma pulses, the lifetime is ~1 plasma day or 1 kC $\approx \frac{1}{4}$ A·h of H⁻, which appears to be typical for CSPS.
- In 2009 the development shifted to the FETS test stand, now reaching 50 Hz
 ~60 mA H⁻ beam at 3 MeV with 10% d.f.

•The Chinese Spallation Source has adopted this source, meeting their initial 20 mA and later 40 mA requirements.

